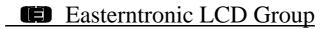
PRODUCT SPECIFICATIONS

GS240128A-Q-BTXTSWW-110

V1.0

August 20, 2008

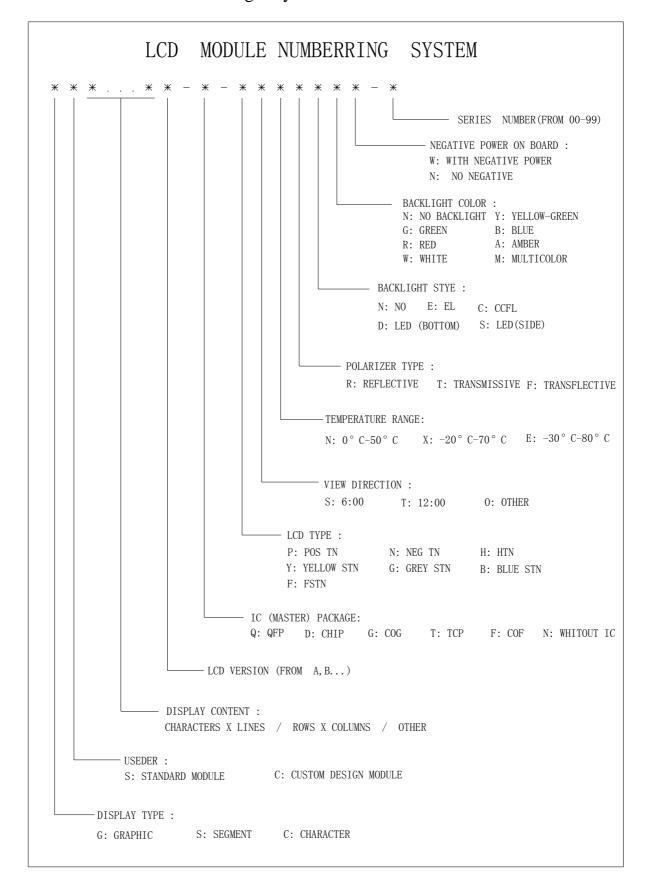


REVISION RECORD

VERSION	DESCRIPTION	DATE
V1.0		August 20, 2008

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1. LCD Module Numbering System

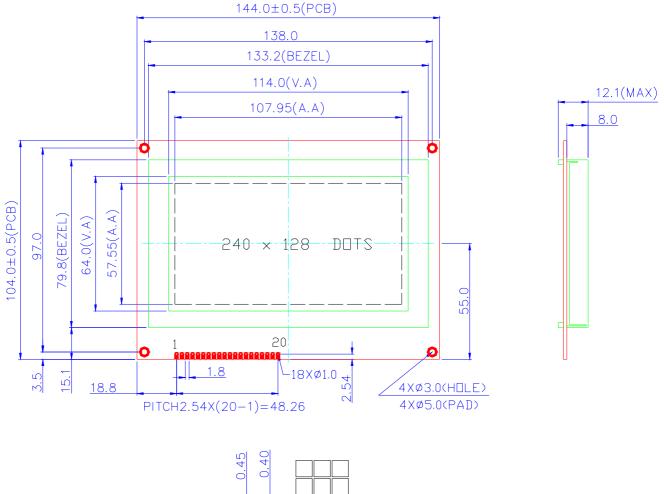
2. TYPE NUMBER AND DESCRIPTION

Type Number	:	GS240128A-Q-BTXTSWW-110
Description	:	240 X 128 DOTS
LCD Panel	:	Blue STN, Negative, Transmissive
Viewing angle	:	12H
Duty and Bias	:	1/128 duty; 1/12 bias
Backlight	:	Side, White LED
Logic Voltage	:	5.0V
Operating Temperature	2:	-20°C70°C
Storage Temperature	:	-30°C80°C
Controller	:	T6963C
Package	:	SMT
DC-DC convertor	:	With
Contrast be fixed on PCI	В	

3. MECHANICAL SPECIFICATIONS:

ITEM	STANDARD VALUE	UNIT
DISPLAY CONTENT	240 H X 128 V DOTS	
MODULE DIMENSION	144.0 (W) X 104.0 (H) X 12.1 (H)	mm
DISPLAY AREA	114.0 (W) X 64.0(H)	mm
DOT SIZE	0.40 (W) X 0.40 (H)	mm
DOT PITCH	0.45 (W) X 0.45 (H)	mm

MODLE DIMENSION DRAWING

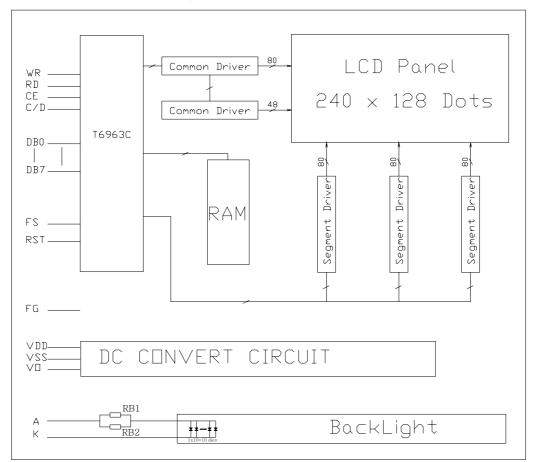


ELECTRICAL BLOCK DIAGRAM 4.

4.1 Pin Definition

	2 0111101011					
PIN	SYMBOL	FUNCTION				
1	FG	Frame Ground				
2	VSS	Power Supply (GND)				
3	VDD	Power Supply (+5.0V)				
4	VO	Operating Voltage for LCD				
5	/WR	Data Write into T6963C, L active				
6	/RD	Data Read from T6963C, L active				
7	/CE	Chip Select				
8	C/D	Command / Data Select				
9	RST	Reset				
10-17	DB0-DB7	Data Bus				
18	FS	Font Select, H: 6x8; L: 8x8				
19	А	Power Supply For Backlight (+)				
20	K	Power Supply For Backlight (-)				

4.2 Electrical Block Diagram



Easterntronic LCD Group

ABSOLUTE MAXIMUM 5. RATINGS

5.1 **Electrical Maximum Ratings**

Characteristic	Symbol	Value	Unit	Note
Operating Voltage	VDD	-0.3~+7.0	V	NOTE*1
Supply Voltage	VEE	VDD-19.0~VDD+0.3	V	NOTE*4
Driver Supply Voltege	VB	-0.3~VDD+0.3	V	NOTE*1,3
Driver Supply Voltage	VLCD	Vee-0.3~Vdd+0.3	V	NOTE*2
Operating Temperature	Topr	-20~+70	°C	
Storage Temperature	Tstg	-30~+80	°C	

NOTE*1. Based on VSS=0V.

NOTE*2 Applies the same supply voltage to VEE1 and VEE2. VLCD=VDD-VEE

Applies to RSTB,CE,RD,WR,C/D, DB0~DB7. NOTE*3

NOTE*4 Applies to V1,V2,V3,V4,V5.

5.2 **Environmental Conditions**

ITEM	SYMB OL	CONDITION	MIN	MA X	UNIT
Operating Temp	Topr	-	-20	70	deg C
Storage Temp	Ttsg	-	-30	80	deg C
Humidity Endurance	RH	RH $\begin{array}{c} \text{no condensation} \\ \text{Ta} < \neq 40 \text{ deg} \end{array}$		95	%
Vibration -		3 directions	see note (a)		-
Shock	-	3 directions	see note (b)		-

varying from 10 Hz in a 1-minute cycle note (a): frequency :

> 1.5mm amplitude :

duration : 120 cycles, each lasting 1 minute,

for each of the 3 directions, x,y,z

nutually perpendicular directions note (b):

direction normal to surface of LCD glass

80G, half-sine pulse of duration 11ms

other 2 directions

100G, half-sine pulse of duration 11ms

ELECTRICAL SPECIFICATIONS 6.

ITEM	SYMBOL	CONDITION	MIN	ТҮР	MAX	UNIT
Supply Voltage (logic)	Vdd-Vss	-	4.5	5.0	5.5	V
Supply Voltage (LCD)	Vdd-V0	Vdd = 5V	15.5	16.0	16.5	V
Input signal voltage	Vih	"H" level	2.8	-	Vdd	V
(for E, DB0-7,R/W,RS)	Vil	"L" level	0	-	0.8	V
Output voltage for Logic	Voh	-Ioh=0.6mA	Vdd- 0.3	-	Vdd	V
	Vol	Iol=1.6mA	0	-	0.3	
Supply Current	Idd	-		8.0	10.0	mA
Supply Voltage (LED)	V-bl	-	2.9	3.1	3.3	V
Supply Current (LED)	I-bl	-	-	150	200	mA

6.1 Electrical Characteristics at Ta=25 deg C, Vdd = 5V + / - 5%

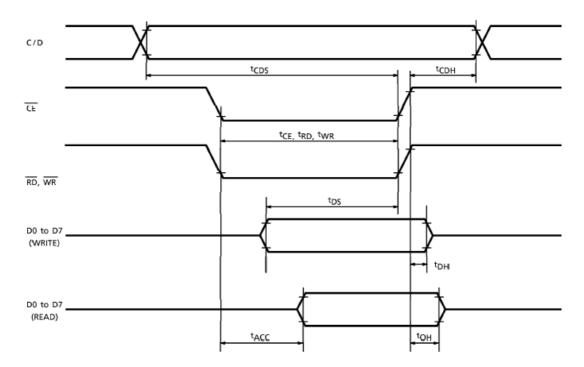
6.2 Timing Specifications

TEST CONDITIONS (Unless otherwise noted, $V_{DD} = 5.0V \pm 10\%$, $V_{SS} = 0V$, Ta = -20 to $70^{\circ}C$)

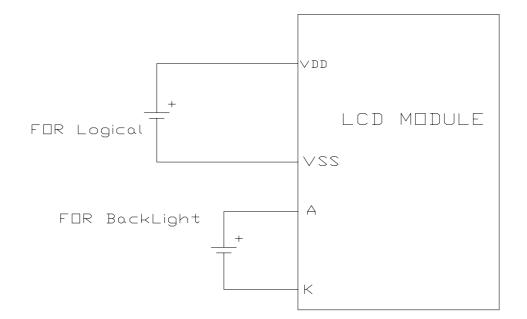
ITEM	SYMBOL	TEST CONDITIONS	MIN	МАХ	UNIT
Operating Frequency	f _{scp}	Ta = - 10~70°C	_	2.75	MHz
SCP Pulse Width	^t CWH ^{, t} CWL	—	150	-	ns
SCP Rise / Fall Time	t _r , t _f	—		30	ns
LP Set-up Time	tlsu	—	150	290	ns
LP Hold Time	tLHD	—	5	40	ns
Data Set-up Time	tDSU	—	170	_	ns
Data Hold Time	^t DHD	—	80	_	ns
FR Delay Time	td	—	0	90	ns
CDATA Set-up Time	tcsu	—	450	850	ns
CDATA Hold Time	^t CHD	_	450	950	ns

Switching Characteristics (2)

Bus Timing



POWER SUPPLY FOR LCD MODULE 7.



ITEM	SYMBOL	CONDI TION	MIN.	TYP.	MAX.	UNIT	REF.
Contrast	CR	25℃		12			Note1
Rise Time	tr	25℃		160	240	ms	Note2
Fall Time	tf	25℃		100	150	ms	note 2
Viewing Angle	θ 1- θ 2	25℃			60	DEG	Note 3
viewing Angle	Ø1, Ø2	250	-40		40	DEG	Note 5
Frame Frequency	Ff	25℃		64		Hz	note 2

8. ELECTRO-OPTICAL CHARACTERISTIC

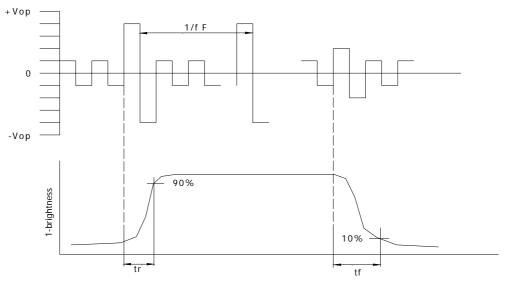
Note(1): Contrast ratio is defined under the following condition:

CR= <u>brightness of selected condition</u>

brightness of non-selected condition

- (a). Temperature-----25C
- (b). Frame Frequency-----64Hz
- (c). Viewing angle----- $\theta = 0, \emptyset = 0$
- (d). Operating Voltage---16.0V

Note(2): definition of response time:

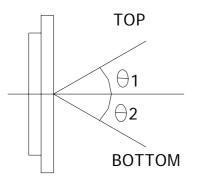


Condition:

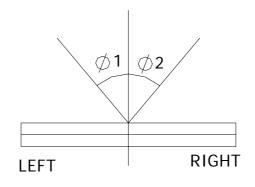
- (a). Temperature-----25C
- (b). Frame Frequency-----64Hz
- (c). Viewing angle----- $\theta = 0, \emptyset = 0$
- (d). Operating Voltage---16.0V

Note(3): definition of view angle:

TOP-BOTTOM DIRECTION



RIGHT-LEFT DIRECTION





9. INSTRUCTION TABLE

COMMAND DEFINITIONS

COMMAND	CODE	D1	D2	FUNCTION
	00100001	X address	Y address	Set Cursor Pointer
REGISTERS SETTING	00100010	Data	00H	Set Offset Register
	00100100	Low address	High address	Set Address Pointer
	01000000	Low address	High address	Set Text Home Address
SET CONTROL WORD	01000001	Columns	00H	Set Text Area
SET CONTROL WORD	01000010	Low address	High address	Set Graphic Home Address
	01000011	Columns	00H	Set Graphic Area
	1000X000	—	_	OR mode
	1000X001	-	_	EXOR mode
MODE SET	1000X011	-	_	AND mode
NODE SET	1000X100	-	_	Text Attribute mode
	10000XXX	_	_	Internal CG ROM mode
	10001XXX	-	_	External CG RAM mode
	10010000	—	_	Display off
	1001XX10	_	_	Cursor on, blink off
DISPLAY MODE	1001XX11	-	_	Cursor on, blink on
DISPLAT WIDDE	100101XX	_	_	Text on, graphic off
	100110XX	-	_	Text off, graphic on
	100111XX	-	_	Text on, graphic on
	10100000	_	_	1-line cursor
	10100001	_	_	2-line cursor
	10100010	-	_	3-line cursor
CURSOR PATTERN	10100011	_	_	4-line cursor
SELECT	10100100	-	_	5-line cursor
	10100101	_	_	6-line cursor
	10100110	-	—	7-line cursor
	10100111	_	—	8-line cursor
DATA AUTO READ/	10110000	—	_	Set Data Auto Write
WRITE	10110001	-	_	Set Data Auto Read
WINIE	10110010	-	_	Auto Reset
	11000000	Data	_	Data Write and Increment ADP
	11000001	_	—	Data Read and Increment ADP
DATA READ/WRITE	11000010	Data	—	Data Write and Decrement ADP
DATA READ/ WKITE	11000011	_	—	Data Read and Decrement ADP
	11000100	Data	—	Data Write and Nonvariable ADP
	11000101	_	_	Data Read and Nonvariable ADP
SCREEN PEEK	11100000	—	_	Screen Peek
SCREEN COPY	11101000			Screen Copy

X : invalid

DESCRIPTION OF T6963C

PLEASE REFER TO DATESHEET OF T6963C

10. PRECAUTION FOR USING LCM

1. LIQUID CRYSTAL DISPLAY (LCD)

LCD is made up of glass, organic sealant, organic fluid, and polymer based polarizers. The following precautions should be taken when handing,

(1). Keep the temperature within range of use and storage. Excessive temperature and humidity could cause polarization degredation, polarizer peel off or bubble.

(2). Do not contact the exposed polarizers with anything harder than an HB pencil lead. To clean dust off the display surface. Wipe gently with cotton. Chamois or other soft material soaked in petroleum benzin.

(3). Wipe off saliva or water drops immediately. Contact with water over a long period of time may cause polarizer deformation or color fading, while an active LCD with water condensation on its surface will cause corrosion of ITO electrodes.

(4). Glass can be easily chipped or cracked from rough handing. especially at corners and edges.

(5). Do not drive LCD with DC voltage.

2. Liquid Crystal Display Modules

2.1 Mechanical Considerations

LCM are assembled and adjusted with a high degree of precision. Avoid excessive shocks and do not make any alterations or modifications. The following should be noted.

(1). Do not tamper in any way with the tabs on the tabs on the metal frame.

(2). Do not modify the PCB by drilling extra holes, changing its outline, moving its components or modifying its pattem.

(3). Do not touch the elastomer connector, especially insert an backlight panel (for example, EL).

(4). When mounting a LCM make sure that the PCB is not under any tress such as bending or twisting. Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.

(5). Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing piels.

2.2. Static Electricity

LCM contains CMOS LSI's and the same precaution for such devices should apply, namely

(1). The operator should be grounded whenever he/she comes into contact with the module. Never touch any of the conductive parts such as the LSI pads, the copper leads on the PCB and the interface terminals with any parts of the human body.

(2). The modules should be kept in antistatic bags or other containers resistant to static for storage.

(3). Only properly grounded soldering irons should be used.

(4). If an electric screwdriver is used, it should be well grounded and shielded from commutator sparks.

(5). The normal static prevention measures should be observed for work clothes and working benches; for the latter conductive (rubber) mat is recommended.

(6). Since dry air is inductive to statics, a relative humidity of 50-60% is recommended.

2.3. Soldering

(1). Solder only to the I/O terminals.

(2). Use only soldering irons with proper grounding and no leakage.

(3). Soldering temperature: 280 $^{\circ}C \pm 10^{\circ}C$

(4). Soldering time: 3 to 4 sec.

(5). Use eutectic solder with resin flux fill.

(6). If flux is used, the LCD surface should be covered to avoid flux spatters. Flux residue should be removed after wards.

2.4. Operation

(1). The viewing angle can be adjusted by varying the LCD driving voltage V0.

(2). Driving voltage should be kept within specified range; excess voltage shortens display life.

(3). Response time increases with decrease in temperature.

(4). Display may turn black or dark blue at temperatures above its operational range; this is (however not pressing on the viewing area) may cause the segments to appear "fractured".

(5). Mechanical disturbance during operation (such as pressing on the viewing area) nay cause the segments to appear "fractured".

2.5. Storage

If any fluid leaks out of a damaged glass cell, wash off any human part that comes into contact with soap and water. Never swallow the fluid. The toxicity is extremely low but caution should be exercised at all the time.

2.6. Limited Warranty

Unless otherwise agreed between EASTERNTRONIC and customer, EASTERNTRONIC will replace or repair any of its LCD and LC, which is found to be defective electrically and visually when inspected in accordance with EASTERNTRONIC acceptance standards, for a period on one year from data of shipment. Confirmation of such date shall be based on freight warranty liability documents. The of EASTERNTRONIC is limited to repair and/or replacement on the terms set forth above. EASTERNTRONIC will not responsible for any subsequent or consequential events.



11. Declaration of conformity regarding the limitation of dangerous substances

深圳易事通液晶显示模块有限公司

SHENZHENEASTERNTRONICLCMCO., LTD.4F, B3 Building, FuYuan Industrial Zone, FuYong Town,
BaoAn District, ShenZhen, P.R. China

DECLARATION OF CONFORMITY REGARDING THE LIMITATION OF DANGEROUS SUBSTANCES

WE, SHENZHEN EASTERNTRONIC LCM CO., LTD,

Declare that the product of GS240128A-Q-BTXTSWW-110 complies with: The directive 2002/95/EC Dated 2003/01/27 regarding the limitation of dangerous substances, in particular to clause 4 which

forbids the use of the following elements:

•Lead

• Mercury

●Cadmium

•Hexavalant chromium

• Polybrominated biphenyls

•Polybrominated diphenylethers

And to the annex which points out the exempted implementations \Box To the dimension 72/22/22 dated 1072/02/10 and the standard

□ To the directive 73/23/eec dated 1973/02/19 and the standard EN60335-1 regarding prohibition of following elements:

• Oils containing polychlorinated bipheny1

• Asbestos

• Radioactive substances

Name: Ewing Liu /

SHENZHEN EASTERNTRONIC LCM CO., LTD.

Issued on August 20, 2008

According with the proposal of Technical Adaption Committee(TAC) of a limit of 0.1% by weight for lead hexavalent chromium, mercury, PBBs and PBDRs and 0.01% by weight for Cadmium.